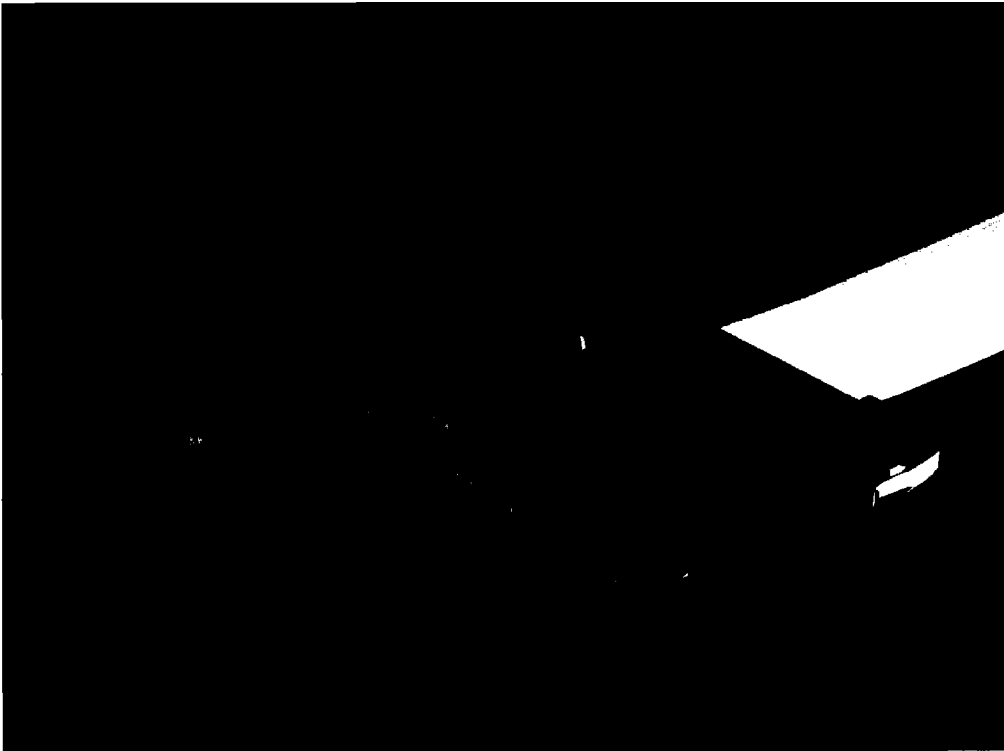


Micro-Strip Interconnection System

(.050 x .100 [1.27 x 2.54] centerline)

*Specifications subject to change.
For latest design specifications...*
1-800-522-6752



AMP Micro-Strip connectors are a high density controlled impedance connector family, compatible with requirements of high density and high speed data transmission technologies.

Each signal line within the mated connector is located at a specific distance from an integral, separable bus bar serving as a ground plane in a Micro Strip configuration. Selection of housing dielectric, spacing from signal contact to ground plane and conductor geometry provide a characteristic impedance plus very low inductance and capacitance.

Discontinuities resulting from connector structure and solder interfaces are dimensionally small and therefore appear transparent to high speed signals. Both vertical and right angle

cable to board connector versions of AMP Micro-Strip connectors share a normal impedance of 50 ohms.

Each one inch length of connector houses two electrically isolated high current contacts. When soldered to the PCB ground plane, that ground plane is extended through the mated connector.

Resistance is minimized by a large contact area and short electrical length, providing signal return paths with negligible ground loop voltages. Since signal return is via the bus bars, signal-ground-signal alternation, common to high speed applications, becomes unnecessary. All contacts can be dedicated to signal transmission, effectively doubling connector density.

Product Facts

- Designed for High Speed Applications
- Provides controlled impedance
- Low inductance
- High density
- Board to Board parallel and right angle to board configurations available in 40 to 240 positions
- Cable to board system in sizes 20 to 120 positions
- Vertical and right angle board mount receptacles for cable connectors
- Connector housings are keyed
- Latching and Keying options available
- Board mount product is compatible with standard through-hole flow solder and vapor phase reflow solder processes
- Recognized under the Component Program of Underwriters Laboratories Inc., File No. E28476
- Certified by Canadian Standards Association, File No. LR7189
- Product Specifications 108-1252 (Cable to Board) 108-1272 (Board to Board)



Dimensioning:

Dimensions are in inches and millimeters. Values in brackets are metric equivalents.

Board to Board Application

Specifications subject to change.
For latest design specifications...
1-800-522-6752

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over millimeters.

Vertical Plug

Housing Material:

Black, high temperature thermoplastic, flame retardant

Bus Bar Material and Finish:

Phosphor bronze alloy plated .000030 [0.00076] gold over .000050 [0.00127] nickel in the mating area, .00015 [0.00381] 60/40 tin-lead over .00025 [0.00635] nickel in terminating area over .00050 [0.0127] nickel plate on the entire bus

Signal Pin Material and Finish:

Phosphor bronze alloy plated .000030 [0.00076] gold over .000050 [0.00127] nickel in the mating area, .00015 [0.00381] 60/40 tin-lead over .00025 [0.00635] nickel in terminating area over .00050 [0.0127] nickel plate on the entire contact

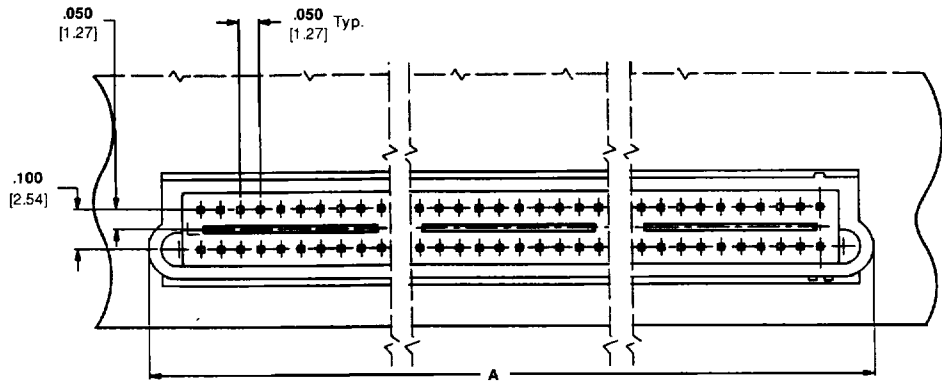
Related Product Data:

Mates with Receptacles — pages 3415 & 3416

Connector — Impedance, 50 ohms ±10% at 1 ns

Configuration — .100 [2.54] signal row to signal row, .050 [1.27] signal to ground, .050 [1.27] signal to signal

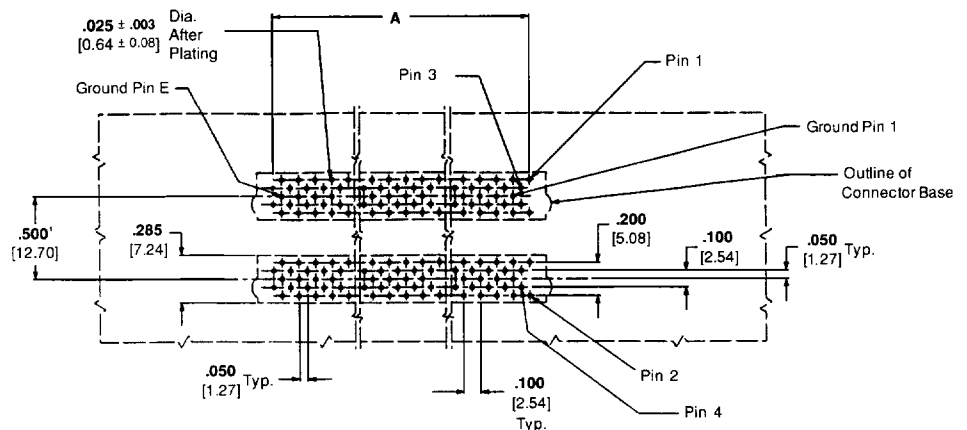
Electrical Testing — Contact AMP Incorporated for crosstalk and impedance profiles



Component Side

No. of Positions	Dimensions		Part Numbers	
	A	B	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
40	1.21 30.73	.950 24.13	121344-1	2-121344-3
60	1.71 43.43	1.450 36.83	121344-2	2-121344-4
100	2.71 68.83	2.450 62.23	121344-4	2-121344-6
140	3.71 94.23	3.450 87.63	121344-6	2-121344-8
160	4.21 106.93	3.950 100.33	121344-7	2-121344-9

Recommended PC Board Layout



Component Side of Board

*Min. functional spacing when mated with a Right Angle Receptacle mounted to a .062 [1.58] pc board.

Board to Board Application

Specifications subject to change.
For latest design specifications...
1-800-522-6752

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over millimeters.

Vertical Receptacle

Housing Material:

Black, high temperature thermoplastic, flame retardant

Bus Receptacle Material and Finish:

Phosphor bronze alloy plated
.000030 [0.00076] gold over
.000050 [0.00127] nickel in the mating area, .00015 [0.00381] 60/40 tin-lead over .00025 [0.00635] nickel in terminating area over .00050 [0.0127] nickel plate on the entire bus

Receptacle Contact Material and Finish:

Beryllium copper alloy 1/2 HM .0070 ±.0004 [0.178 ±0.010] plated
.000030 [0.00076] gold over
.000050 [0.00127] nickel with .00050 [0.0127] nickel plate on the entire contact

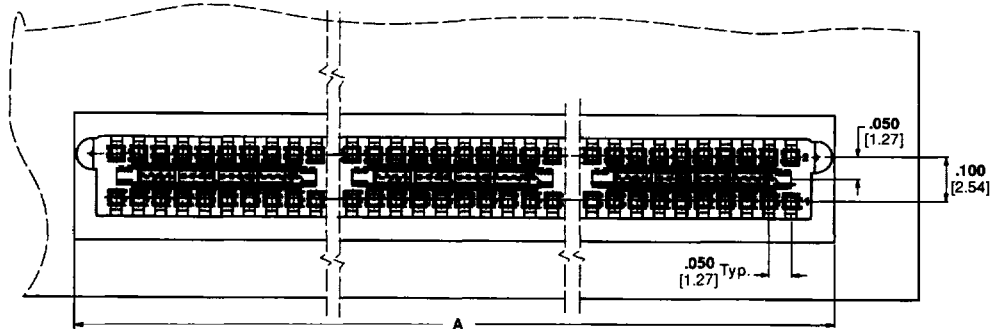
Related Product Data:

Mates with Plug — page 3414

Connector — Impedance, 50 ohms ±10% at 1 ns

Configuration — .100 [2.54] signal row to signal row, .050 [1.27] signal to ground, .050 [1.27] signal to signal

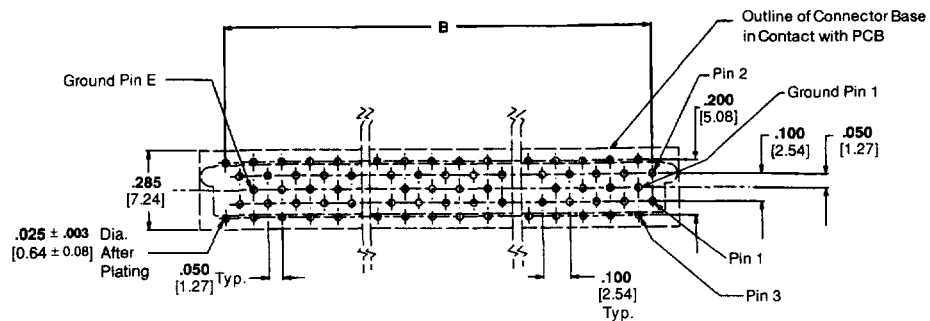
Electrical Testing — Contact AMP Incorporated for crosstalk and impedance profiles



Component Side

No. of Positions	Dimensions		Part Numbers	
	A	B	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
40	1.140 28.96	.950 24.13	121340-1	2-121340-3
60	1.640 41.66	1.450 36.83	121340-2	2-121340-4
100	2.640 67.06	2.450 62.23	121340-4	2-121340-6

Recommended PC Board Layout



Component Side of Board

Board to Board Application

**Specifications subject to change.
For latest design specifications...
1-800-522-6752**

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over
millimeters.

Right-Angle Receptacle

Bus Receptacle Material and Finish:

Phosphor bronze alloy plated
.000030 [0.00076] gold over
.000050 [0.00127] nickel in the
mating area. .00015 [0.00381] 60/40
tin-lead over .00025 [0.00635] nickel
in terminating area over .00050
[0.0127] nickel plate on the entire
bus

Receptacle Contact Material and Finish:

Beryllium copper alloy 1/2 HM .0070
±.0004 [0.178 ±0.010] plated
.000030 [0.00076] gold over
.000050 [0.00127] nickel with
.00050 [0.0127] nickel plate on the
entire contact

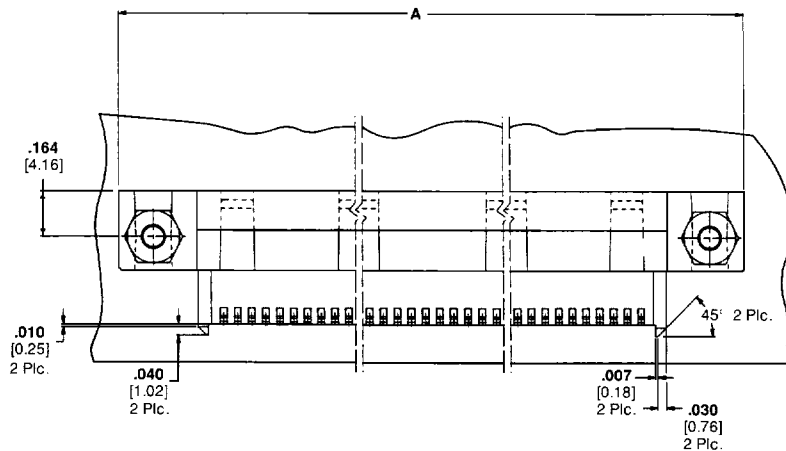
Related Product Data:

Mates with Plug — Plug, page 3414

Connector — Impedance, 50 ohms
±10% at 1 ns

Configuration — .100 [2.54] signal
row to signal row, .050 [1.27] signal
to ground. .050 [1.27] signal to
signal

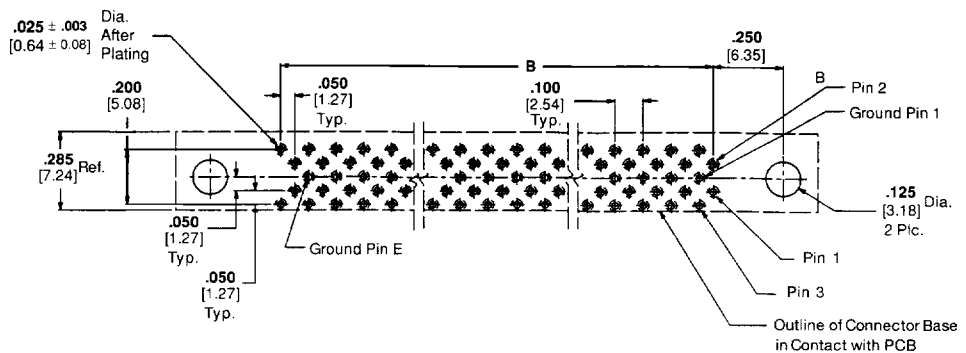
Electric Testing — Contact AMP
Incorporated for crosstalk and
impedance profiles



Component Side

No. of Positions	Dimensions		Part Numbers	
	A	B	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
40	1.700 43.18	.950 24.13	121330-1	2-121330-3
140	4.200 27.94	3.455 9.02	121330-6	2-121330-8
160	4.700 35.56	3.950 9.40	121330-7	2-121330-9

Recommended PC Board Layout



Component Side of Board

Cable to Board Application

Specifications subject to change.
For latest design specifications...
1-800-522-6752

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over millimeters.

Vertical Receptacle

Housing Material:

Black, high temperature thermoplastic, flame retardant

Bus Receptacle Material and Finish:

Phosphor bronze alloy plated .000030 [0.00076] gold over .000050 [0.00127] nickel in the mating area, .00015 [0.00381] 60/40 tin-lead over .00025 [0.00635] nickel in terminating area over .00050 [0.0127] nickel plate on the entire bus

Contact Material and Finish:

Beryllium copper alloy plated .000030 [0.00076] gold min. in contact area over .000050 [0.00127] min. nickel on the entire contact

Related Product Data:

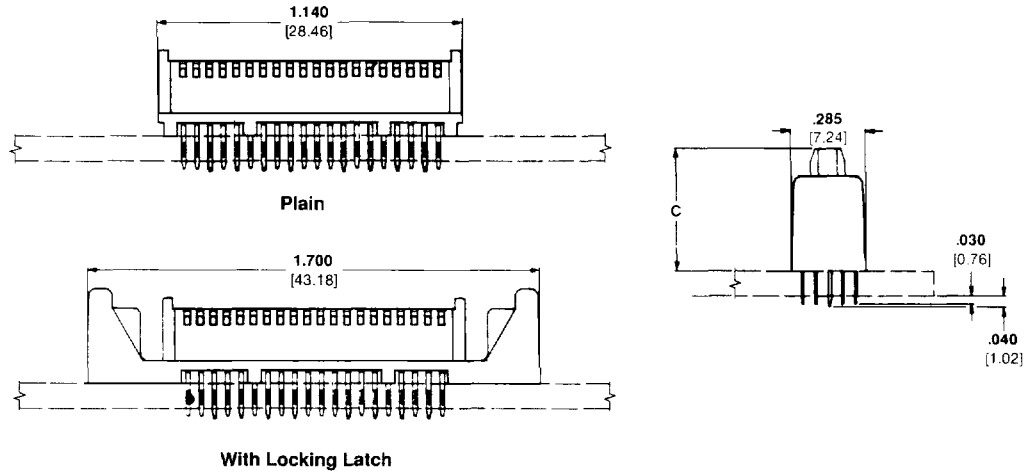
Cable Assembly Ordering Information — page 3420

Connector — Impedance, 50 ohms ± 10% at 1 ns

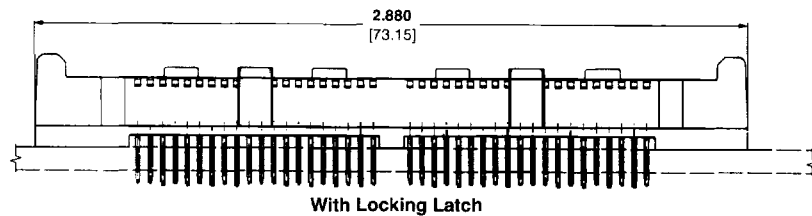
Configuration — .100 [2.54] signal row to signal row, .050 [1.27] signal to ground, .050 [1.27] signal to signal

Electrical Testing — Contact AMP Incorporated for crosstalk and impedance profiles

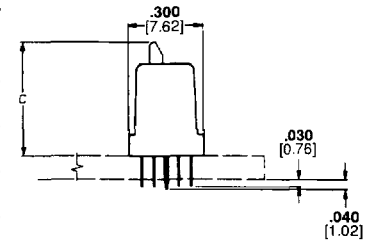
40 Position



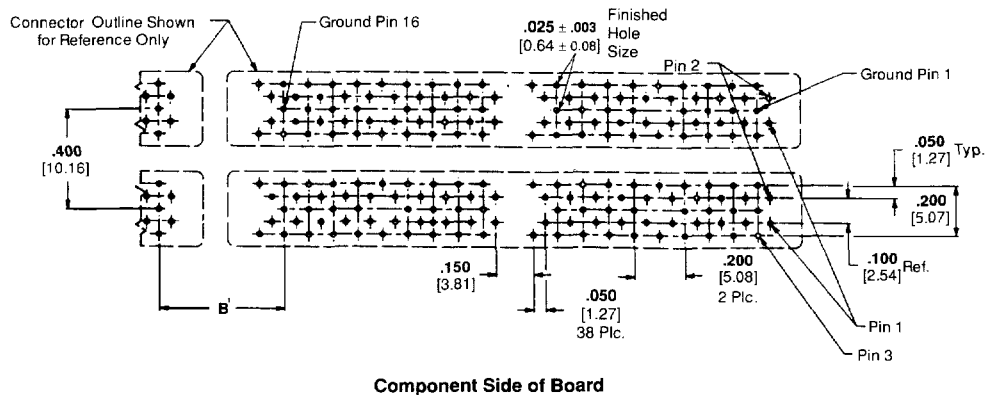
80 Position



No. of Positions	Dimensions		Part Numbers	
	B	C	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
40 Plain	.950 24.13	.320 8.13	121286-1	121286-3
40 W/Latch	1.100 27.94	.355 9.02	121286-6	121286-8
80 W/Latch	1.400 35.56	.370 9.40	121288-6	121288-8



Recommended PC Board Layout — 80 Position Connector



*Min. functional spacing.

**Specifications subject to change.
For latest design specifications...
1-800-522-6752**

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over millimeters.

Cable to Board Application

Right Angle Receptacle

Housing Material:

Black, high temperature thermoplastic, flame retardant

Bus Receptacle Material and Finish:

Phosphor bronze alloy plated .000030 [0.00076] gold over .000050 [0.00127] nickel in the mating area, .00015 [0.00381] 60/40 tin-lead over .00025 [0.00635] nickel in terminating area over .00050 [0.0127] nickel plate on the entire bus

Contact Material and Finish:

Beryllium copper alloy plated .000030 [0.00076] gold min. in contact area over .000050 [0.00127] min. nickel on the entire contact

Related Product Data:

Cable Assembly Ordering Information — page 3420

Connector — Impedance, 50 ohms ±10% at 1 ns

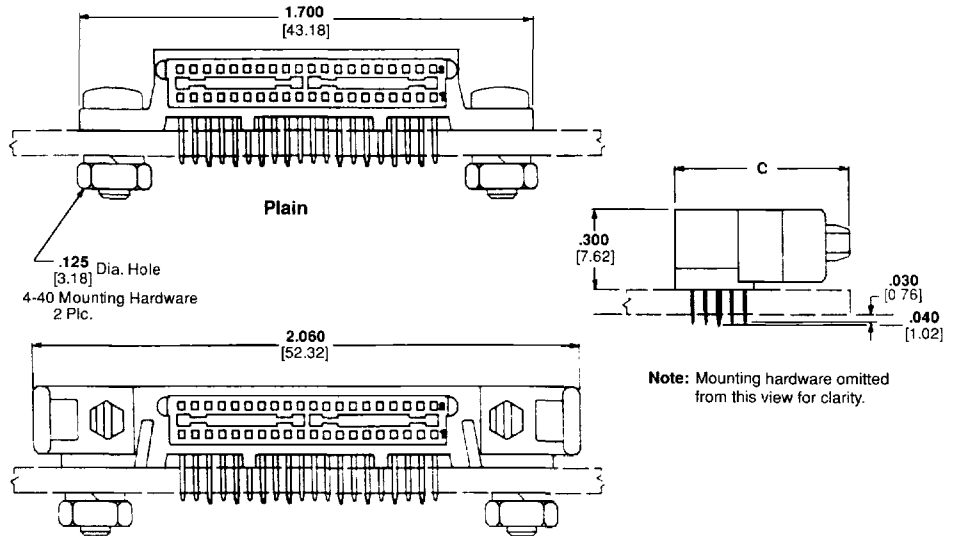
Configuration — .100 [2.54] signal row to signal row, .050 [1.27] signal to ground, .050 [1.27] signal to signal

Electrical Testing — Contact AMP Incorporated for crosstalk and impedance profiles

	A
	B
	C
	D
	E
	F
ILLUSTRATION	KEY CODE
RECOMMENDED CODES FOR PROGRAMMABLE KEYS	

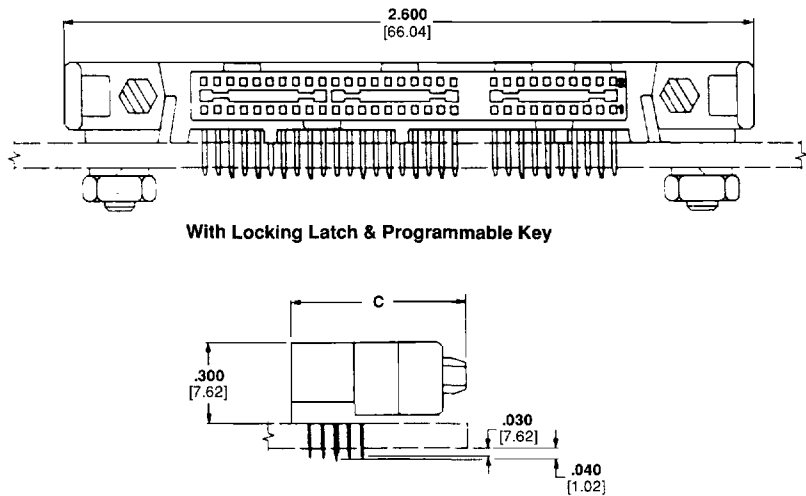
	A
	B
	C
	D
	E
	F
ILLUSTRATION	KEY CODE
RECOMMENDED CODES FOR PROGRAMMABLE KEYS	

40 Position



With Locking Latch & Programmable Key

60 Position



Note: Mounting hardware omitted from this view for clarity.

No. of Positions	Dimensions		Part Numbers	
	B	C	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
40 Plain	.950 24.13	.520 13.21	121281-1	121281-3
40 W/Latch, Key	1.700 43.18	.665 16.89	1-121281-1	1-121281-3
60 W/Latch, Key	1.700 43.18	.665 16.89	1-121282-1	1-121282-3

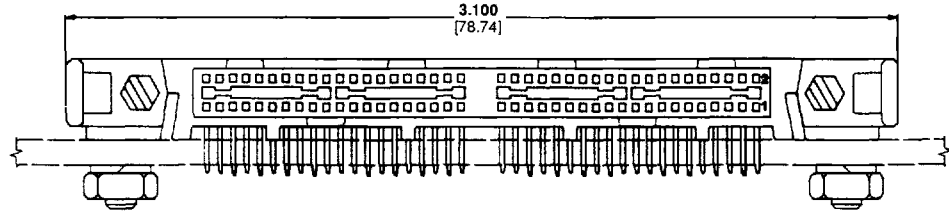
Cable to Board Application (Continued)

**Specifications subject to change.
For latest design specifications...
1-800-522-6752**

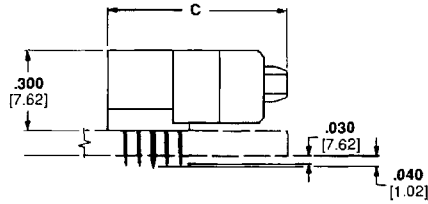
Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.

	A
	B
	C
	D
	E
	F
ILLUSTRATION	KEY CODE
RECOMMENDED CODES FOR PROGRAMMABLE KEYS	

80 Position

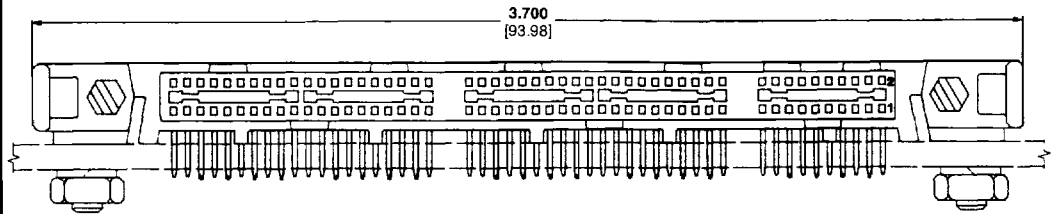


With Locking Latch & Programmable Key



Note: Mounting hardware omitted from this view for clarity.

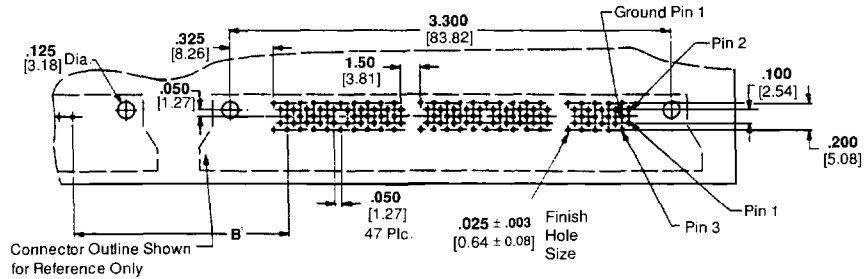
100 Position



With Locking Latch & Programmable Key

No. of Positions	Dimensions		Part Numbers	
	B	C	.062 [1.58] Thk. PC Board	.125 [3.18] Thk. PC Board
80 W/Latch, Key	1.700 43.18	.665 16.89	1-121283-1	1-121283-3
100 W/Latch, Key	1.700 43.18	.665 16.89	1-121284-1	1-121284-3

Recommended PC Board Layout



Component Side of Board

¹Min. functional spacing.

Cable Assembly

*Specifications subject to change.
For latest design specifications...
1-800-522-6752*

Dimensioning:
Dimensions are in inches and millimeters.
Values in brackets are metric equivalents.
Chart contains dimensions in inches over millimeters.

Material Specifications

Housing Material:

Black, high temperature thermoplastic, flame retardant

Signal Contacts:

Phosphor bronze with .000030 [.000762] min. select gold over .000030 [.000762] min. nickel plate, in contact area

Ground Bus:

Brass with .000030 [.000762] min. select gold plate over .000030 [.000762] min. nickel plate, in contact area

Electrical Specifications

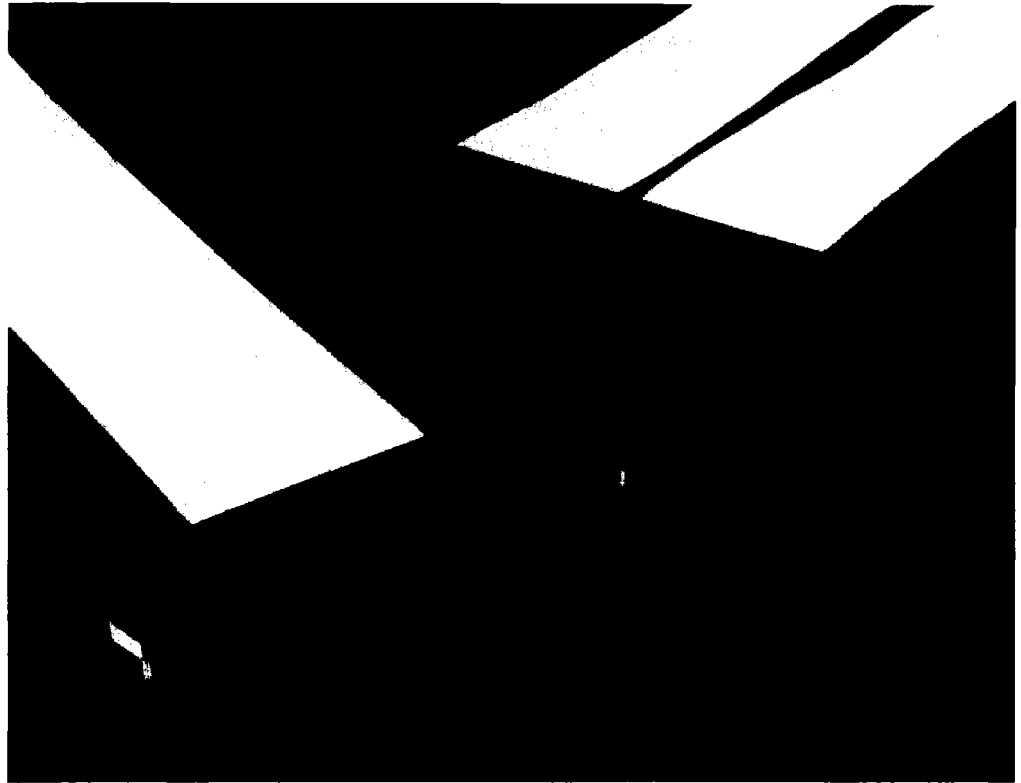
Impedance — 50 ohms \pm 10% at 1 ns

Propagation delay — 1.45 \pm .03 ns/ft [4.757 \pm .098 ns/m]

Cable insulation material — FEP or equivalent

Conductor resistance — .144 ohms/ft [.472 ohms/m]

Configuration — Signal ground signal (Planar Transmission) Signals are on .025 [0.64] spacing



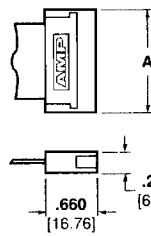
3 Printed Circuit Board Connectors

Cable Assembly Ordering Information

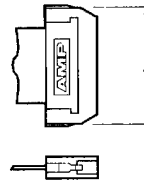
No. of Pos.	Dimension A		
	Plain	Latch	Latch/Key
20	—	—	1.420 36.07
40	1.320 33.50	1.500 38.10	1.920 48.77
60	—	—	2.460 62.48
80	—	2.620 66.55	2.960 75.18
100	—	3.220 81.79	3.560 90.42

- Notes:**
1. Assembly length is measured from mating face to mating face of cable connector.
 2. Minimum cable assembly length is 3.00 [76.2].
 3. Cable assemblies mate with cable-to-board receptacles only.

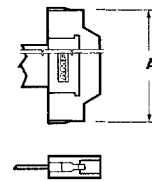
20, 40 Position



Plain



Latch



Latch/Key

60, 80, 100 Position

